

#### 1.6X0.8mm PHOTOTRANSISTOR

Part Number: KP-1608P1C

#### **Features**

- 1.6mmX0.8mm SMT LED, 1.1mm thickness.
- Mechanically and spectrally matched to infrared emitting

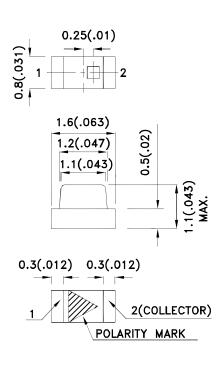
LED lamp.

- Water clear lens.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

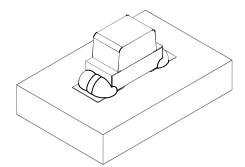
### Description

Made with silicon phototransistor chips.

### **Package Dimensions**









- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1 (0.004")$  unless otherwise noted
- 3.The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
  4.The device has a single mounting surface. The device must be mounted according to the specifications.

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# Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
VBR CEO	Collector-to-Emitter Breakdown Voltage	30			V	Ic=100uA Ee=0mW/c m²
VBR ECO	Emitter-to-Collector Breakdown Voltage	5			٧	IE=100uA Ee=0mW/c m³
VCE (SAT)	Collector-to-Emitter Saturation Voltage			0.8	V	Ic=2mA Ee=20mW/c m²
I CEO	Collector Dark Current			100	nA	Vc=10V Ee=0mW/c m³
TR	Rise Time (10% to 90%)		15		us	VCE = 5V IC=1mA RL=1000Ω
TF	Fall Time (90% to 10%)		15		us	
I (ON)	On State Collector Current	0.1	0.3		mA	VcE = 5V Ee=1mW/c m³ λ=940nm
201/2	Viewing Angle		120		deg	

# Absolute Maximum Ratings at TA=25°C

Parameter	Max.Ratings			
Collector-to-Emitter Voltage	30V			
Emitter-to-Collector Voltage	5V			
Power Dissipation at (or below) 25°C Free Air Temperature	100mW			
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

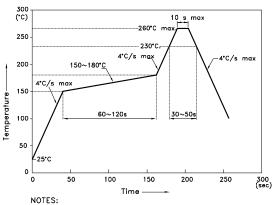
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### **KP-1608P1C**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

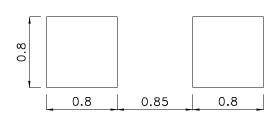
Reflow Soldering Profile For Lead-free SMT Process.



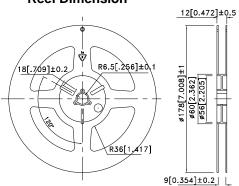
1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3. Number of reflow process shall be 2 times or less.

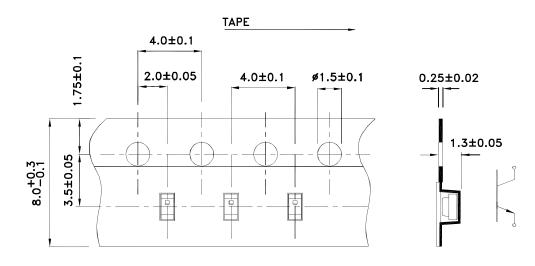
# Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### **Reel Dimension**

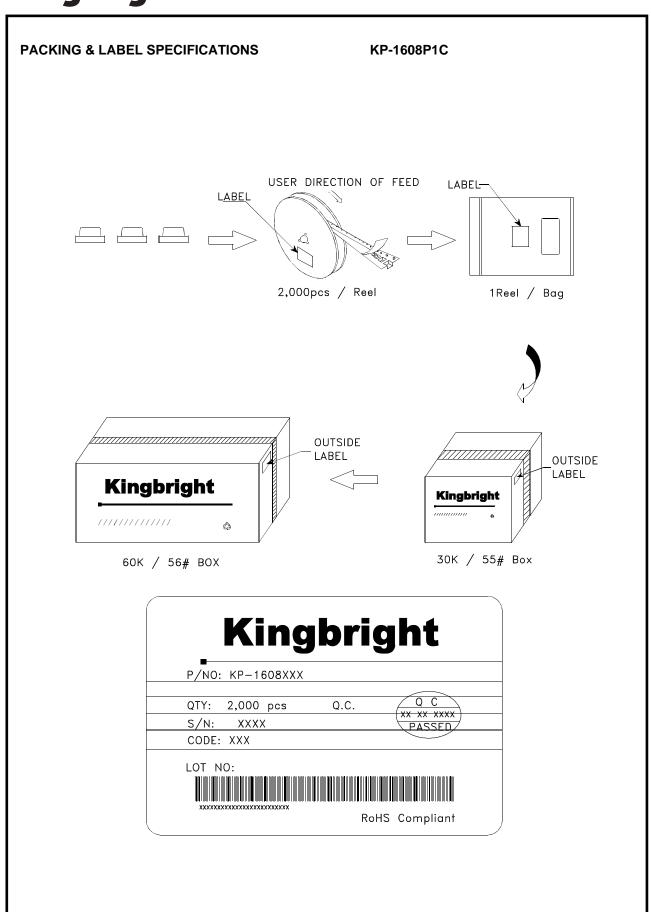


Tape Specifications (Units: mm)



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